

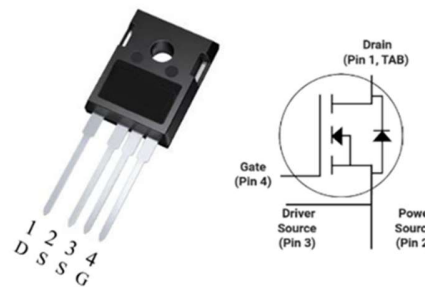
NW6504CJ1-4

650V N-Channel Silicon Carbide Power MOSFET

Parameter	Value	Unit
V_{DS}	650	V
$R_{DS(on)}$	39	m Ω
I_D	78	A

Features

- Optimized package with separate driver source pin
- High blocking voltage with low on-resistance
- Low on-resistance with high junction temperature
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Easy to parallel
- RoHS compliant



Applications

- Switch Mode Power Supplies
- DC/DC Converters
- Solar Inverters
- EV charging infrastructure
- Energy storage & battery
- Battery control unit

Description

The NW6504CJ1-4 is a 650V N-Channel Silicon Carbide Power MOSFET based on NovaWave's advanced SiC technology resulting in high performance and long-term reliability. It supports high-temperature operation while showing minimal losses, zero reverse recovery, and low leakage current.

Pin Description

Part Number	Package	Marking
NW6504CJ1-4	TO247-4	NW6504CJ1-4

Absolute Maximum Ratings, at $T_J = 25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit	Test conditions
Drain-Source Breakdown Voltage	V_{DSmax}	650	V	$V_{GS} = 0\text{ V}$, $I_D = 100\text{ }\mu\text{A}$
Continuous Drain Current	I_D	78	A	$V_{GS} = 20\text{ V}$, $T_C = 25^{\circ}\text{C}$
		55	A	$V_{GS} = 20\text{ V}$, $T_C = 100^{\circ}\text{C}$
Pulsed Drain Current	$I_{D(pulse)}$	156	A	Pulse width t_p limited by T_{jmax}
Power Dissipation	P_D	362	W	$T_C = 25^{\circ}\text{C}$
Recommend Gate Source Voltage	$V_{GS,op}$	-5/+20	V	
Maximum Gate Source Voltage	V_{GSmax}	-10/+25	V	AC ($f > 1\text{Hz}$)
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to +175	$^{\circ}\text{C}$	
Soldering Temperature	T_L	260	$^{\circ}\text{C}$	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.414	$^{\circ}\text{C/W}$

Electrical Characteristics, at $T_J = 25^{\circ}\text{C}$, unless otherwise specified

Parameters	Symbol	Min	Typ	Max	Unit	Condition
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	650	--	--	V	$V_{GS} = 0\text{ V}$, $I_D = 100\text{ }\mu\text{A}$
Zero Gate Voltage Drain Current	I_{DSS}	--	10	100	μA	$V_{DS} = 650\text{ V}$, $V_{GS} = 0\text{ V}$
Gate-Source Leakage	I_{GSS}	--	5	250	nA	$V_{GS} = 20\text{ V}$

Gate-Source Threshold Voltage	$V_{GS(th)}$	2	--	4	V	$I_D = 5 \text{ mA}, V_{GS} = V_{DS}$
Drain-Source On-State Resistance	$R_{DS(on)}$	--	39	80	m Ω	$V_{GS} = 20 \text{ V}, I_D = 13.2 \text{ A}$
		--	52	--	m Ω	$V_{GS} = 18 \text{ V}, I_D = 13.2 \text{ A}$
Input Capacitance	C_{iss}	--	1129	--	pF	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$ $f = 1.0 \text{ MHz}, V_{AC} = 25 \text{ mV}$
Output Capacitance	C_{oss}	--	114	--		
Reverse Transfer Capacitance	C_{rss}	--	6.5	--		
C_{oss} Stored Energy	E_{oss}	--	25	--	μJ	
Total Gate Charge	Q_g	--	62	--	nC	$V_{DS} = 400 \text{ V}$ $I_D = 13.2 \text{ A}$ $V_{GS} = -5/+20 \text{ V}$
Gate-Source Charge	Q_{gs}	--	18	--		
Gate-Drain Charge	Q_{gd}	--	33	--		
Turn-on Delay Time	$t_{d(on)}$	--	132.6	--	ns	$V_{DS} = 400 \text{ V}$ $V_{GS} = -5/+20 \text{ V}$ $I_D = 13.2 \text{ A}$ $R_{G(ext)} = 2.5 \Omega$
Turn-on Rise Time	t_r	--	42.7	--		
Turn-off Delay Time	$t_{d(off)}$	--	21.3	--		
Turn-off Fall Time	t_f	--	14.5	--		
Internal Gate Resistance	$R_{G(int)}$	--	2.8	--	Ω	$f = 1.0 \text{ MHz}, V_{AC} = 25 \text{ mV}$

Body Diode Characteristics, at $T_J = 25^\circ\text{C}$, unless otherwise specified

Parameters	Symbol	Min	Typ	Max	Unit	Condition
Continuous Diode Forward Current	I_S	--	--	78	A	

Diode pulse Current	$I_{S(\text{pulse})}$	--	156	--	A	
Diode Forward Voltage	V_{SD}	--	3.0	--	V	$V_{GS} = 0 \text{ V}, I_S = 6.6 \text{ A}$
Reverse Recovery Time	t_{rr}	--	23	--	ns	$I_S = 13.2 \text{ A}, V_{DS} = 400 \text{ V}$ $V_{GS} = -5 \text{ V}$ $\text{dif}/\text{dt} = 2100 \text{ A}/\mu\text{s}$
Reverse Recovery Charge	Q_{rr}	--	132	--	nC	
Peak Reverse Recovery Current	I_{rrm}	--	13	--	A	

Electrical Performance Graphs

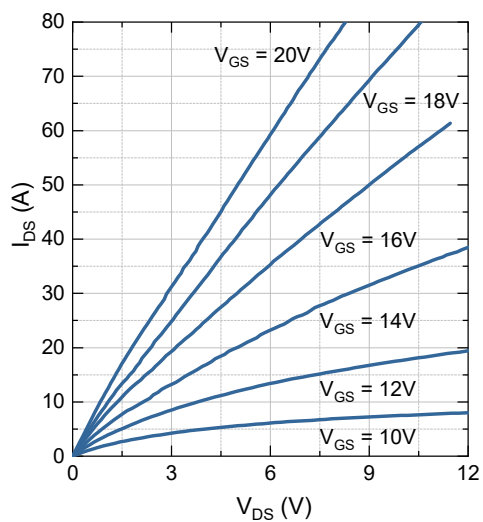


Figure 1: Typical Output Characteristics at $T_j = -55\text{ }^{\circ}\text{C}$

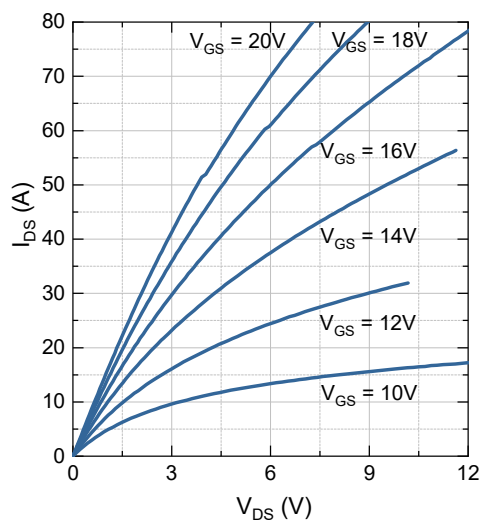


Figure 2: Typical Output Characteristics at $T_j = 25\text{ }^{\circ}\text{C}$

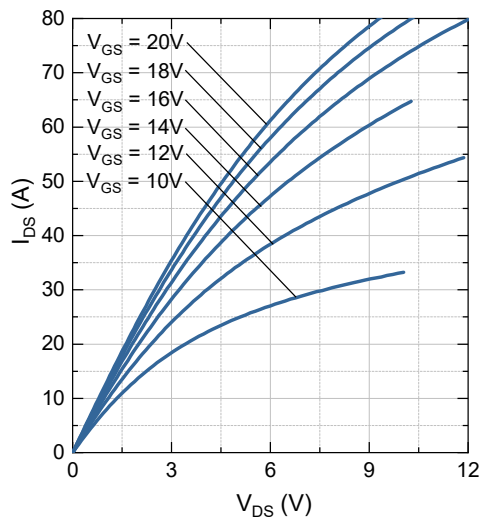


Figure 3: Typical Output Characteristics at $T_j = 175\text{ }^{\circ}\text{C}$

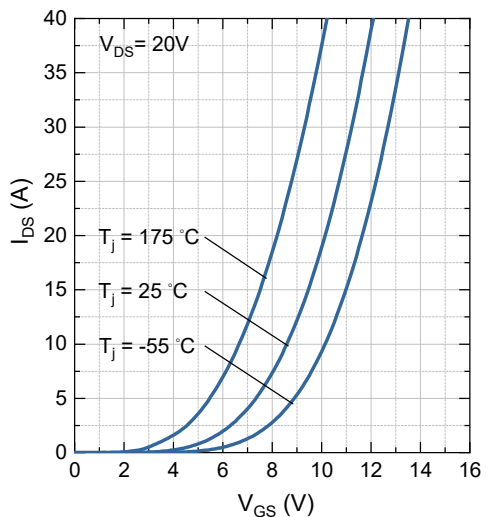


Figure 4: Typical Transfer Characteristics for Various Temperature

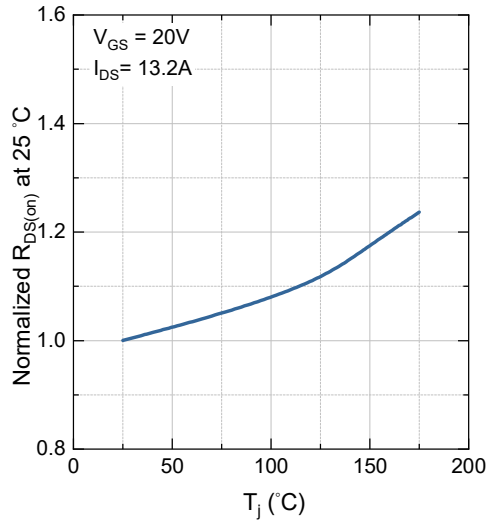


Figure 5: Normalized On-Resistance vs. Temperature

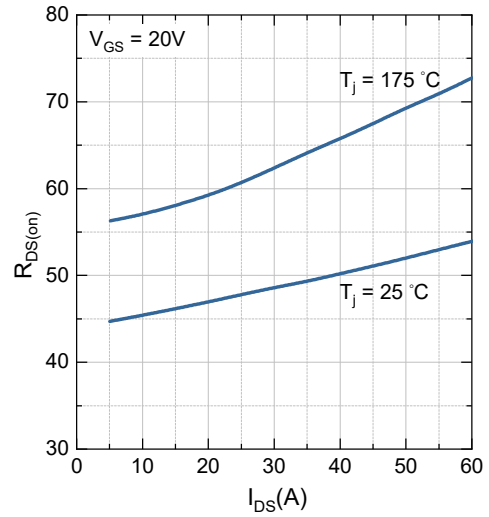


Figure 6: On-Resistance vs. Drain Current for Gate Various Temperatures

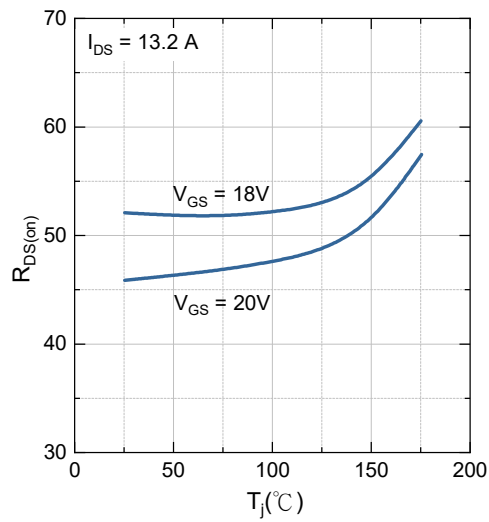


Figure 7: On-Resistance vs. Temperature for Gate Various Voltage

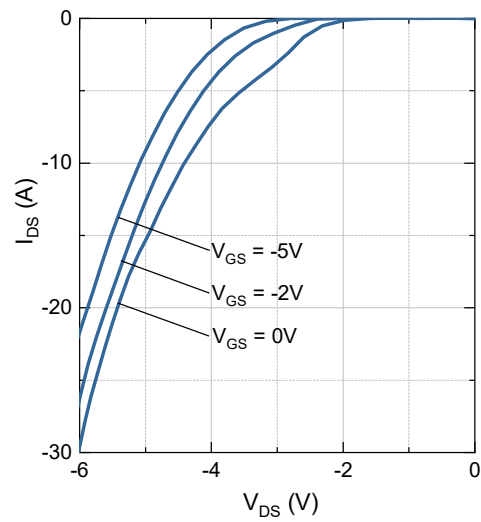


Figure 8: Typical Body Diode Characteristics at $T_J = -55\text{ }^{\circ}\text{C}$

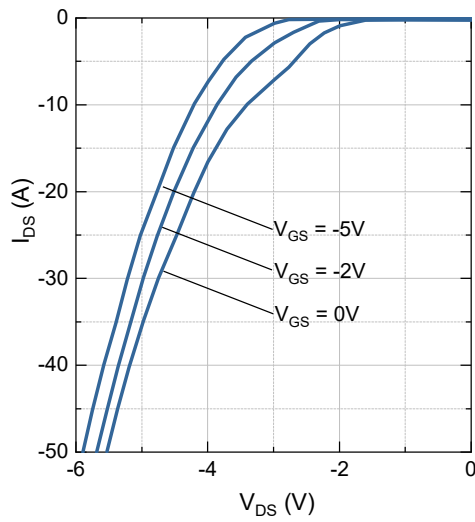


Figure 9: Typical Body Diode Characteristics at $T_j = 25\text{ }^{\circ}\text{C}$

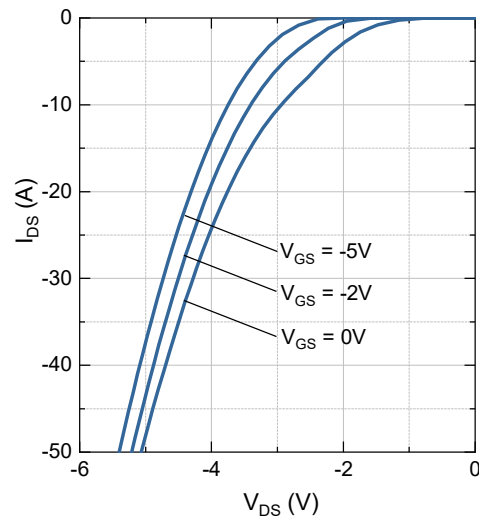


Figure 10: Typical Body Diode Characteristics at $T_j = 175\text{ }^{\circ}\text{C}$

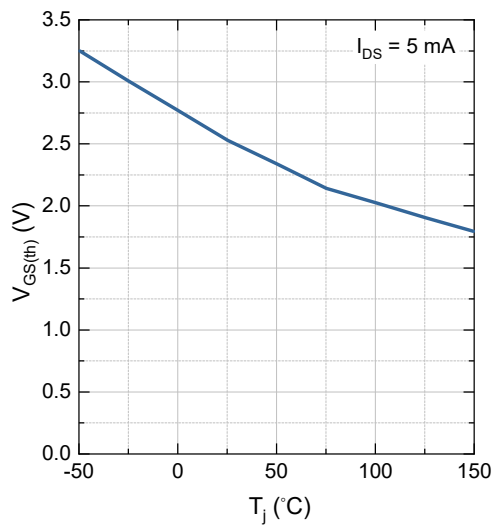


Figure 11: Typical Threshold Voltage vs. Temperature

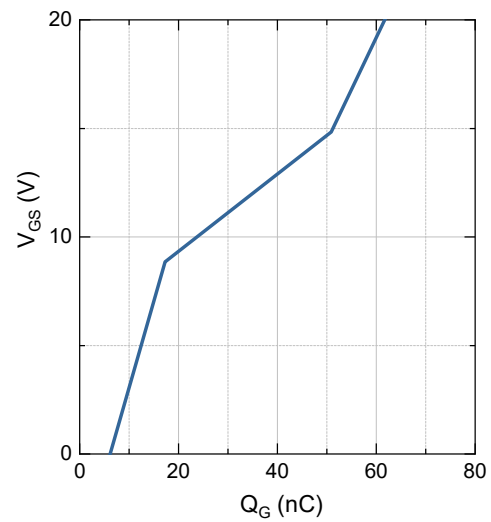


Figure 12: Typical Gate Charge Characteristics at $T_j = 25\text{ }^{\circ}\text{C}$

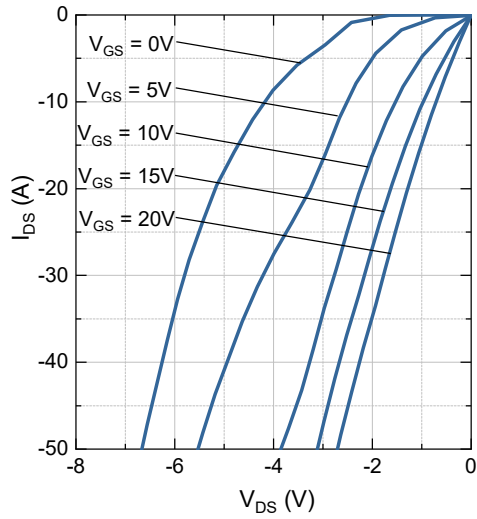


Figure 13: Typical 3rd Quadrant Characteristics $T_J = -55\text{ }^{\circ}\text{C}$

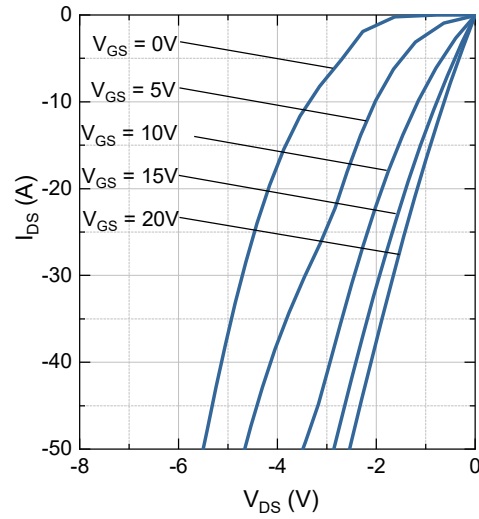


Figure 14: Typical 3rd Quadrant Characteristics $T_J = 25\text{ }^{\circ}\text{C}$

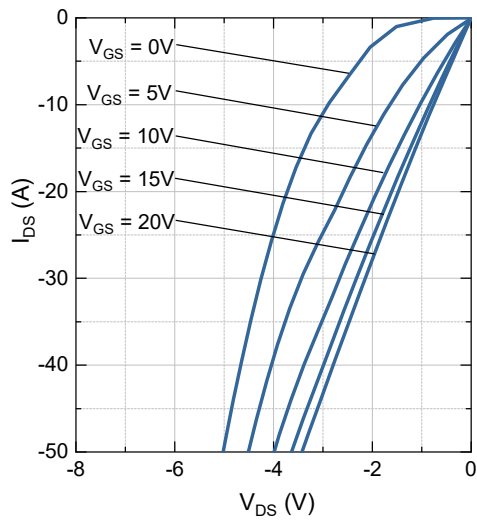


Figure 15: Typical 3rd Quadrant Characteristics $T_J = 175\text{ }^{\circ}\text{C}$

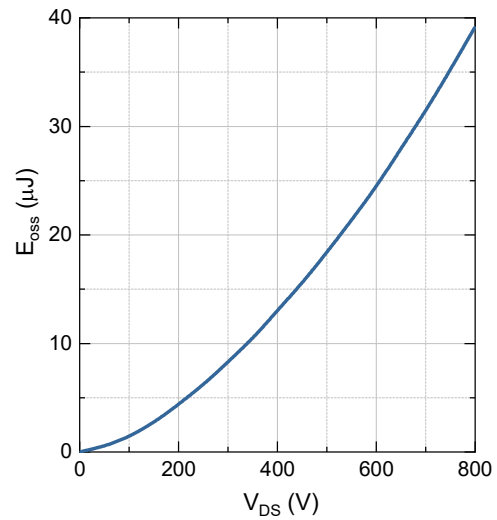


Figure 16: Typical Output Capacitor Stored Energy

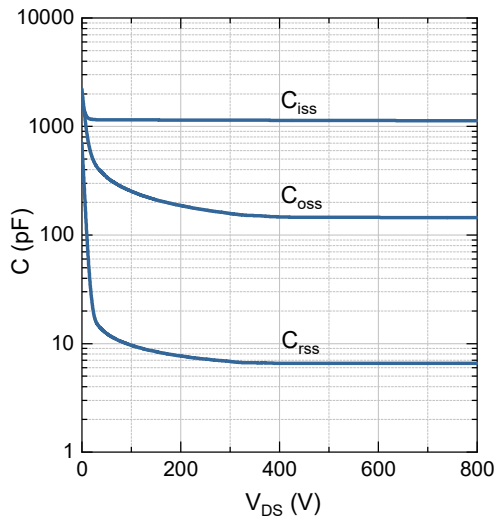


Figure 17: Typical Capacitances vs. Drain-Source Voltage

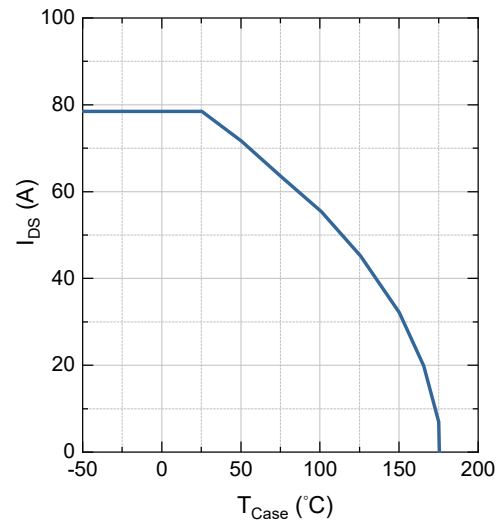


Figure 18: Continuous I_{DS} Current Derating Curve

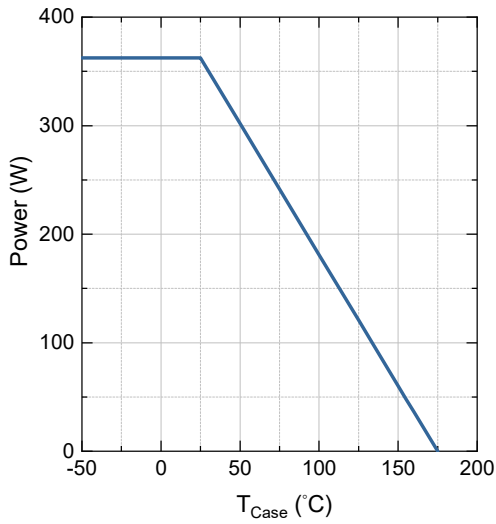


Figure 19: Power Dissipation Derating Curve

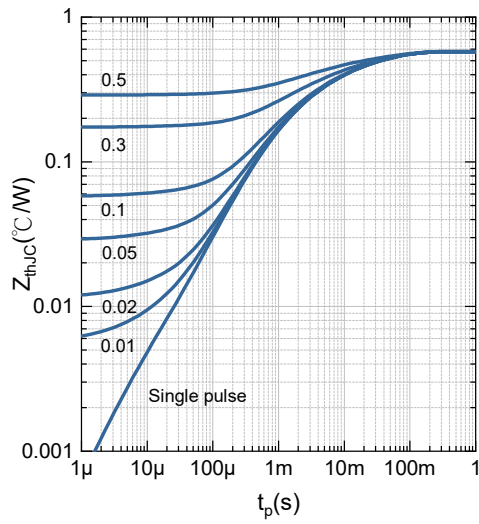


Figure 20: Typical Transient Thermal Impedance (Junction – Case) with Duty Cycle

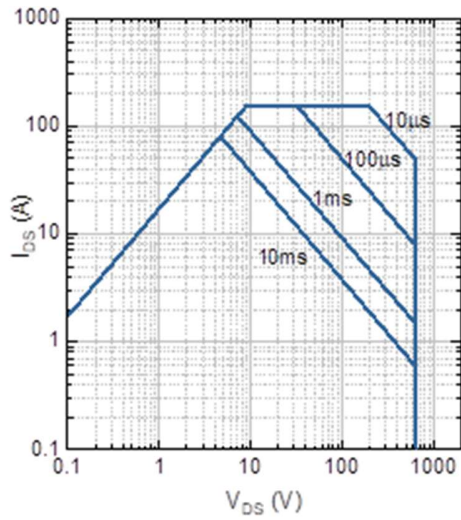


Figure 21: Safe Operating Area

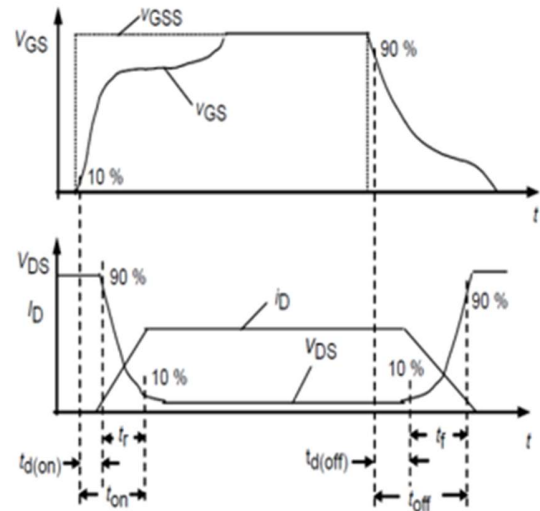


Figure 22: Resistive Switching Time Description

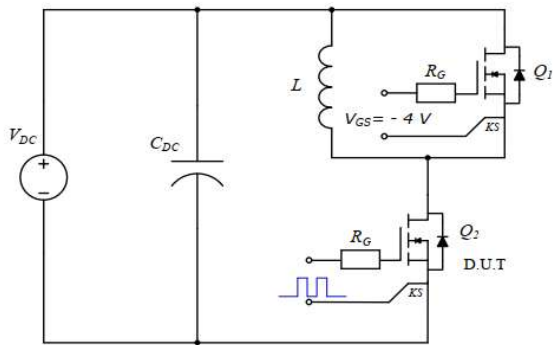
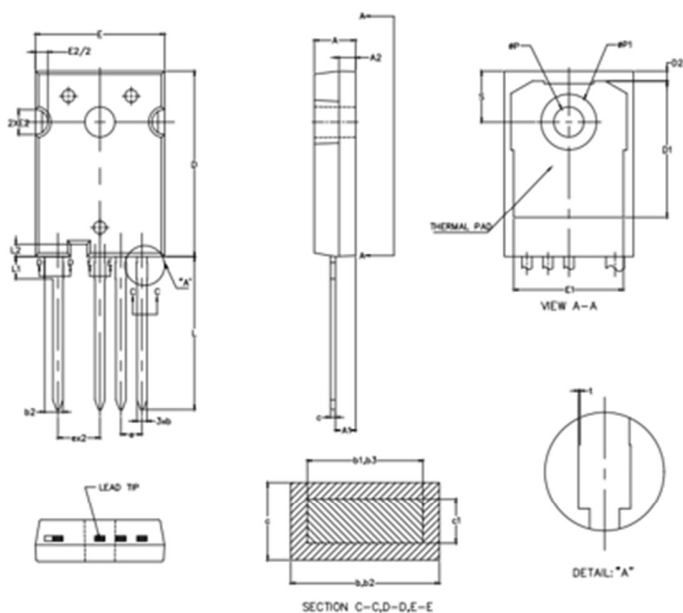


Figure 23: Clamped Inductive Switching Waveform Test Circuit

Package Dimensions

Package: TO247-4



SYMBOL	DIMENSIONS			
	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A	4.90	5.10	0.193	0.201
A1	2.31	2.51	0.091	0.099
A2	1.90	2.10	0.075	0.083
b	1.16	1.26	0.046	0.050
b1	1.15	1.22	0.045	0.048
b2	2.16	2.26	0.085	0.089
b3	2.15	2.22	0.085	0.087
c	0.59	0.66	0.023	0.026
c1	0.58	0.62	0.023	0.024
D	22.40	22.60	0.882	0.890
D1	16.25	16.85	0.640	0.663
D2	1.05	1.35	0.041	0.053
E	15.75	15.90	0.620	0.626
E1	13.26	—	0.552	—
E2	2.90	3.10	0.114	0.122
e	2.54BSC		0.1BSC	
L	18.30	18.60	0.720	0.732
L1	—	2.80	—	0.110
L2	—	1.50	—	0.059
øP	3.50	3.70	0.138	0.146
øP1	—	7.40	—	0.291
S	6.05	6.25	0.238	0.246
t	0.00	0.15	0.000	0.006

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